



Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm

NOTE:

- MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY , SQ=0.40±0.03MM
- FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u")MIN Ni OVER ALL
- SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
- THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 5 SEC. IN A WAVE SOLDER APPLICATION
WITH A PCB.
- PRODUCT NUMBERING:
20021111 - 0 0 0 XX X X LF

LEAD FREE
PLATING:
1: GOLD FLASH, ALL OVER
4: 0.25um(10u")GOLD AT CONTACT
8: 0.76um(30u")GOLD AT CONTACT
PACKING
T: TUBE

PIN COUNT
06,08,10,...., 98,A0
(6 -100 EVERY EVEN PIN)

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mat'l. code				tolerances unless otherwise specified		CUSTOMER COPY	FCI www.fciconnect.com	
ltr	ecn no	dr	date	linear	.X ± 0.38	projection	title 1.27X1.27MM BTB,HEADER UNSHROUDED,VERTICAL,TH	
A	T09-1117	S.LIN	09/15/09		.XX ± 0.25			
B	T10-0011	S.LIN	01/22/10	angles	.XXX ± 0.10	MM	product family 585	
				0° ±2°			size dwg no	
				dr	STERLING LIN	09/15/09	code	
				engr	STERLING LIN	09/15/09	TWN	
				chr	GARY HSIEH	09/15/09	sheet	
				appd	JOSEPH HSIA	09/15/09	1 of 1	
sheet index	revision sheet	B	1			scale	NA	A4
								20021111